

ECENC DJ5VU

TVS Diode Array For ESD and Latch-Up Protection

The ECENC DJ5VU TVS array is designed to protect sensitive electronics from damage or latch-up due to ESD and other voltage-induced transient events. It is designed for use in applications where board space is at a premium. Each device will protect up to five lines. It is unidirectional devices and may be used on lines where the signal polarities are above ground. TVS Diode Array For ESD and Latch-Up Protection

Features

- Protects five I/O lines
- Low capacitance
- Working voltages : 5V
- Low leakage current
- Response Time is < 1 ns
- Low operating and clamping voltages
- ROHS compliant
- Meets MSL 1 Requirements
- Solid-state silicon avalanche technology
- Weight 3 milligrams (Approximate)



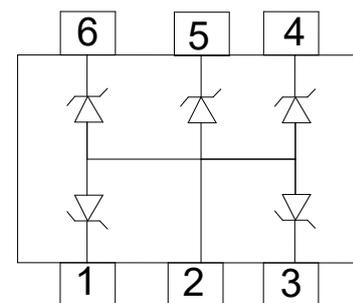
SOT-563

Main applications

- Cellular Handsets and Accessories
- Cordless Phones
- Personal Digital Assistants (PDA's)
- Notebooks and Handhelds
- Portable Instrumentation
- Digital Cameras
- Peripherals
- MP3 Players

Protection solution to meet

- IEC61000-4-2 (ESD) ±15kV (air), ±8kV (contact)
- IEC61000-4-4 (EFT) 40A (5/50ns)



Ordering Information

Device	Qty per Reel	Reel Size
ECENC DJ5VU	3000	7 Inch

Maximum ratings (Tamb=25°C Unless Otherwise Specified)			
Parameter	Symbol	Value	Unit
Peak Pulse Power (tp=8/20µs waveform)	P _{PPP}	40	Watts
Peak Pulse Current(tp=8/20µs waveform)	I _{PP}	3	A
ESD Rating per IEC61000-4-2:	Contact	8	KV
	Air	15	
Lead Soldering Temperature	T _L	260 (10 sec.)	°C
Operating Temperature Range	T _J	-55 ~ 150	°C
Storage Temperature Range	T _{STG}	-55 ~ 150	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

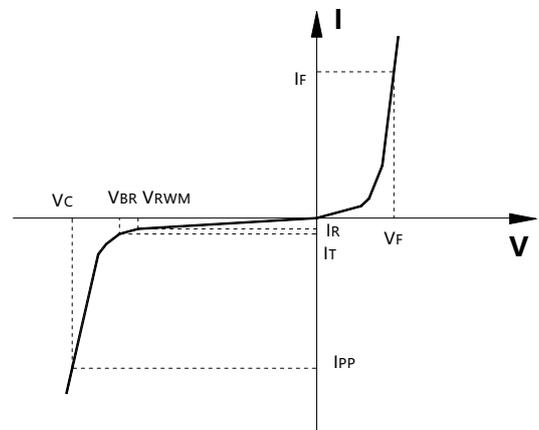
*Other voltages may be available upon request.

1. Non-repetitive current pulse, per Figure 1.

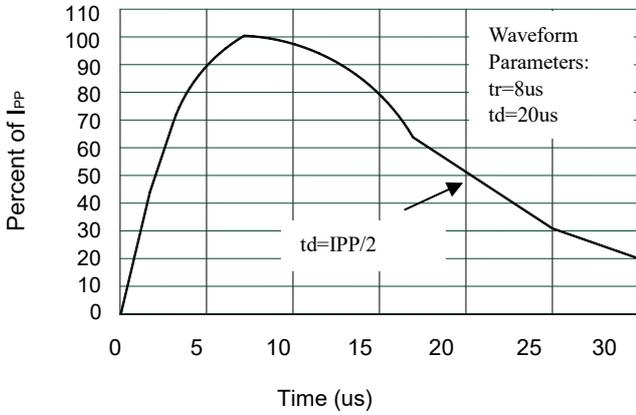
Electrical characteristics (Tamb=25°C Unless Otherwise Specified)						
Symbol	Parameter	Conditions	Min.	Typ.	Max.	Units
V _{RWM}	Reverse Working Voltage				5.0	V
V _{BR}	Reverse Breakdown Voltage	I _T = 1mA,	6.0			V
I _R	Reverse Leakage Current	V _{RWM} = 5V,		0.05	0.5	µA
V _F	Diode Forward Voltage	I _F = 15mA		0.85	1.2	V
V _C	Clamping Voltage	I _{PP} = 1A, tp =8/20µs,			9.5	V
		I _{PP} = 3A, tp =8/20µs,			12	V
I _{PP}	Peak Pulse Current	tp =8/20µs			3	A
C _J	Junction Capacitance	V _R = 0V, f = 1MHz,		17	20	pF

Junction capacitance is measured in VR=0V,F=1MHz

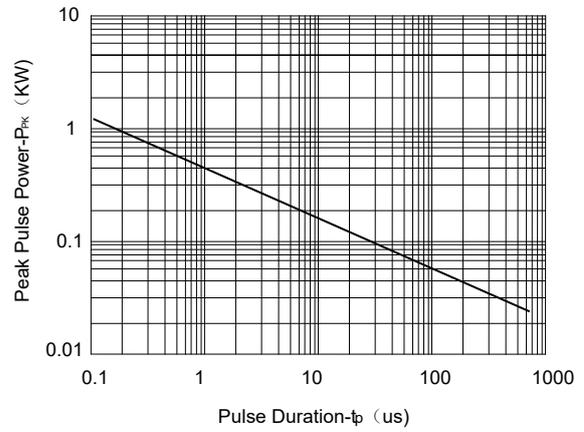
Symbol	Parameter
V _{RWM}	Working Peak Reverse Voltage
V _{BR}	Breakdown Voltage @ I _T
V _C	Clamping Voltage @ I _{PP}
I _T	Test Current
I _{RM}	Leakage current at V _{RWM}
I _{PP}	Peak pulse current
C _O	Off-state Capacitance
C _J	Junction Capacitance



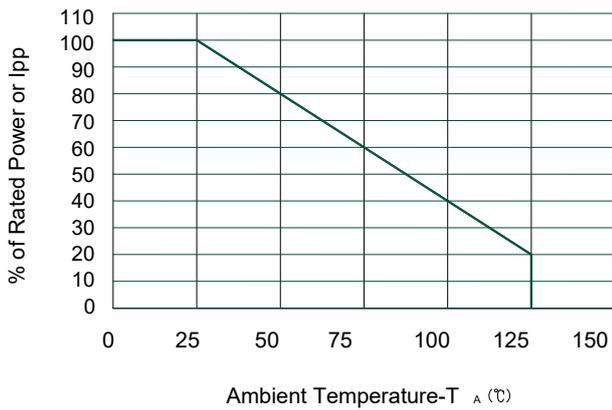
Typical electrical characterist applications



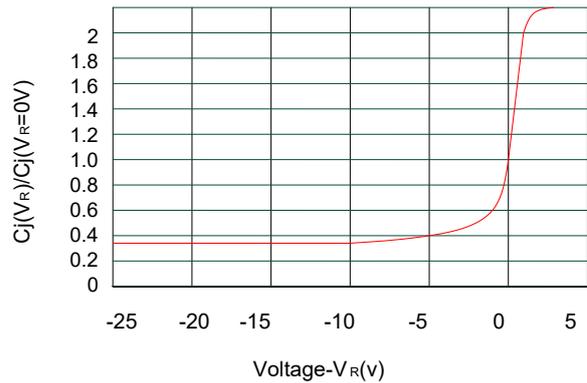
Pulse Waveform



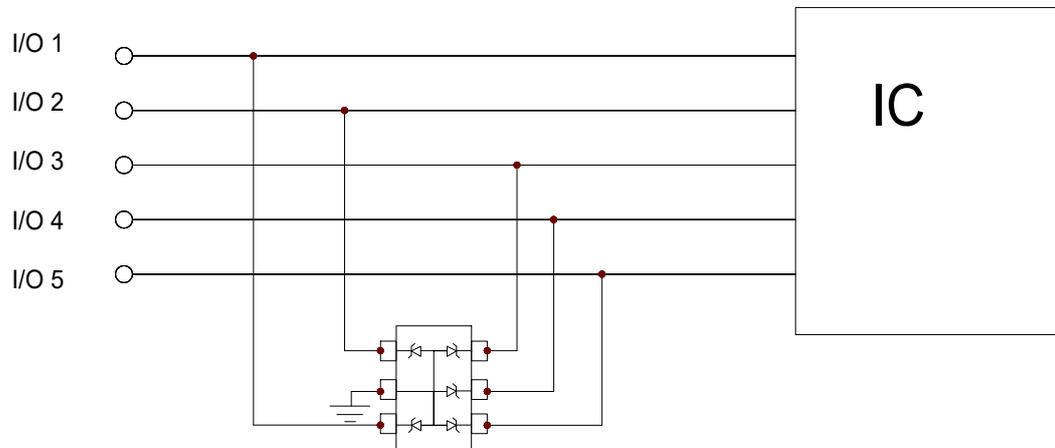
Non-Repetitive Peak Pulse Power vs. Pulse Time



Power Derating Curve



Junction Capacitance vs. Reverse Voltage

Typical applications

Device Connection for Protection of Five Data Lines

The ECENCDJ5VU is designed to protect up to five unidirectional data lines. The device is connected as follows:

Unidirectional protection of five I/O lines is achieved by connecting pins 1, 3, 4, 5 and 6 to the data lines. Pin 2 is connected to ground. The ground connection should be made directly to the ground plane for best results. The path length is kept as short as possible to reduce the effects of parasitic inductance in the board traces.

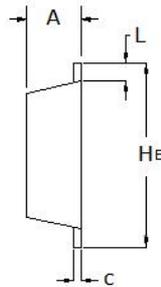
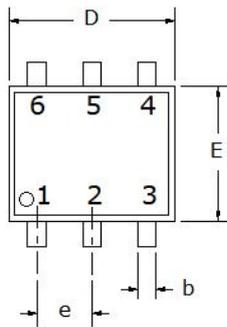
Package Information

SOT-563

Mechanical Data

Case: SOT-563

Case Material: Molded Plastic. UL Flammability



Dim	Millimeters	
	Min	Max
A	0.525	0.60
b	0.17	0.27
c	0.09	0.16
D	1.50	1.70
E	1.10	1.30
e	0.50BSC	
L	0.10	0.30
HE	1.50	1.70

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Recommended Pad outline

